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May 1998 FAIRCHILD SEMICONDUCTOR TM NDS9945 **Dual N-Channel Enhancement Mode Field Effect Transistor General Description** Features SO-8 N-Channel enhancement mode power field effect = 3.5 A, 60 V. $\mathrm{R}_{\mathrm{DS(ON)}}$ = 0.100 Ω @ V $_{\mathrm{GS}}$ = 10 V, transistors are produced using Fairchild's proprietary, high $\mathsf{R}_{\rm DS(ON)} = 0.200 \ \Omega \ @ \ \mathsf{V}_{\rm GS} = 4.5 \ \mathsf{V}.$ cell density, DMOS technology. This very high density process is especially tailored to provide superior switching High density cell design for extremely low R_{DS(ON)}. performance and minimize on-state resistance. These High power and current handling capability in a widely devices are particularly suited for low voltage applications used surface mount package. such as disk drive motor control, battery powered circuits where fast switching, low in-line power loss, and resistance Dual MOSFET in surface mount package. to transients are needed. SOIC-16 SOT-23 SuperSOT[™]-6 SuperSOT[™]-8 SOT-223 SO-8 **D2** 5 4 **D2** D1 6 3 D1 2 7 G2 **S2** 8 G1 1 **SO-8** pin[′]1 **S**1 **Absolute Maximum Ratings** $T_{A} = 25^{\circ}C$ unless other wise noted Parameter Symbol NDS9945 Units V_{DSS} Drain-Source Voltage 60 V Gate-Source Voltage V_{GSS} ±20 V Drain Current - Continuous 3.5 А I_{D} (Note 1a) - Pulsed 10 P_{D} Power Dissipation for Dual Operation 2 W Power Dissipation for Single Operation 1.6 (Note 1a) 1 (Note 1b) 0.9 (Note 1c) °C T_,T_{STG} Operating and Storage Temperature Range -55 to 150 THERMAL CHARACTERISTICS R_{_{AJA}} Thermal Resistance, Junction-to-Ambient (Note 1a) 78 °C/W

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Thermal Resistance, Junction-to-Case

(Note 1)

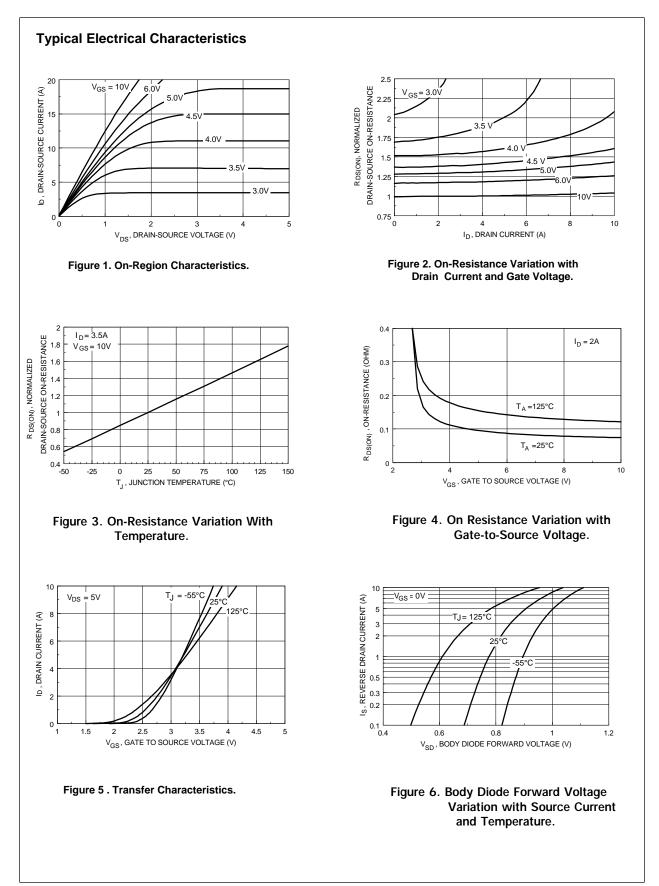
NDS9945 Rev.B

°C/W

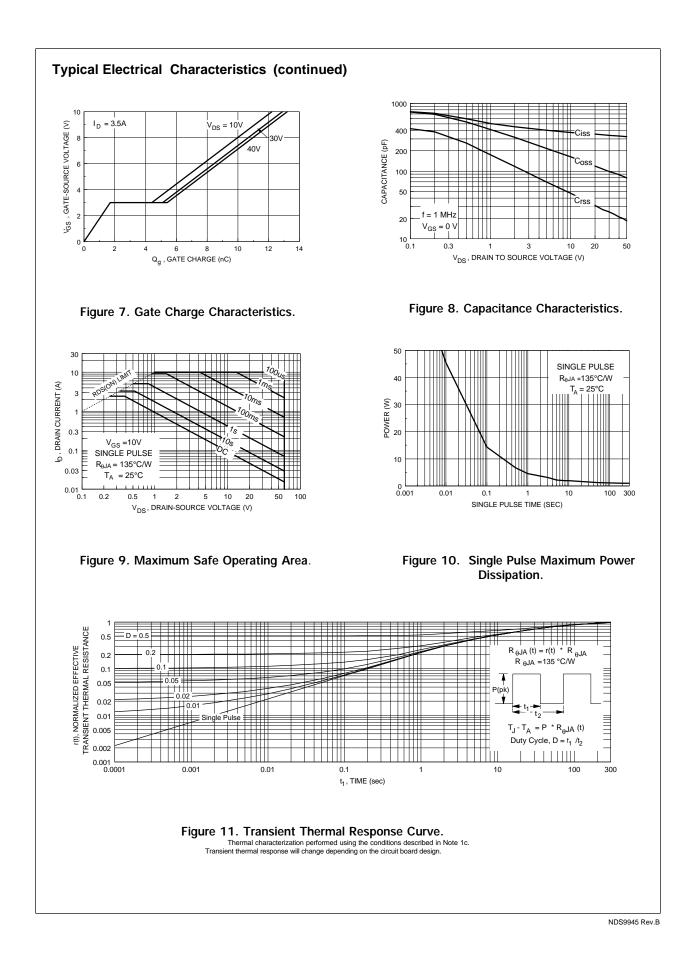
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 $\mathsf{R}_{\theta \mathsf{JC}}$

OFF CHARA BV _{DSS} ΔBV _{DSS} /ΔT _J		Conditions		Min	Тур	Max	Units
	ACTERISTICS			1			I
	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		60			V
	Breakdown Voltage Temp. Coefficient	$I_{\rm p}$ = 250 µA, Referenced to 25 °C			60		mV/ °C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 48 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$				1	μA
GSSF	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
GSSR	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
	CTERISTICS (Note 2)	00 00		1			
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1	1.7	3	V
00(0)	_		T_ =125°C	0.7		2.2	
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3.5 \text{ A}$	5		0.076	0.1	Ω
50(01)			T_ =125°C		0.124	0.18	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	5		0.103	0.2	
			T_ =125°C		0.166	0.3	
D(ON)	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 10 \text{ V}$	5	10			Α
D _{ES}	Forward Transconductance	$V_{\rm GS} = 10 \text{ V}, V_{\rm DS} = 10 \text{ V}$ $V_{\rm DS} = 10 \text{ V}, I_{\rm D} = 3.5 \text{ A}$			5.3		S
	H ARACTERISTICS	03 / 0					I
C _{iss}	Input Capacitance	$V_{ps} = 25 V, V_{cs} = 0 V.$			345		pF
D _{oss}	Output Capacitance	f = 1.0 MHz	$V_{DS} = 25 V, V_{GS} = 0 V,$ f = 1.0 MHz		110		pF
C _{rss}	Reverse Transfer Capacitance				25		pF
	CHARACTERISTICS (Note 2)				_		
D(on)	Turn - On Delay Time	$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 1 \text{ A}$			5	25	ns
r	Turn - On Rise Time	$V_{GS} = 10 \text{ V}$, $R_{GEN} = 6 \Omega$			7.5	30	-
D(off)	Turn - Off Delay Time				20	50	
D(0II)	Turn - Off Fall Time				7	40	
<u></u>	Total Gate Charge	$V_{DS} = 30 \text{ V}, \text{ I}_{D} = 3.5 \text{ A},$ $V_{GS} = 10 \text{ V}$			12.9	30	nC
\mathbf{Q}_{gs}	Gate-Source Charge				1.7		
Q _{qd}	Gate-Drain Charge	33 5			3.2		
ě.	RCE DIODE CHARACTERISTICS AND MAX	XIMUM RATINGS					1
s	Maximum Continuous Drain-Source Diode Fo	orward Current				1.3	Α
/ _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 1.3 A$ (Not	e 2)		0.8	1.2	V
	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, \text{ I}_{F} = 1.3 \text{ A},$ $dI_{F}/dt = 100 \text{ A}/\mu\text{s}$			40		ns
rr	Reverse Recovery Current				1.5		Α



NDS9945 Rev.B



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